

REV	DESCRIPTION	DATE
—	RELEASE	Nov 10, 2003
B	04'0251	Mar 02, 2004
C	04'0313	Mar 06, 2004
D	04'0332	Mar 17, 2004
E	04'0342	Mar 24, 2004

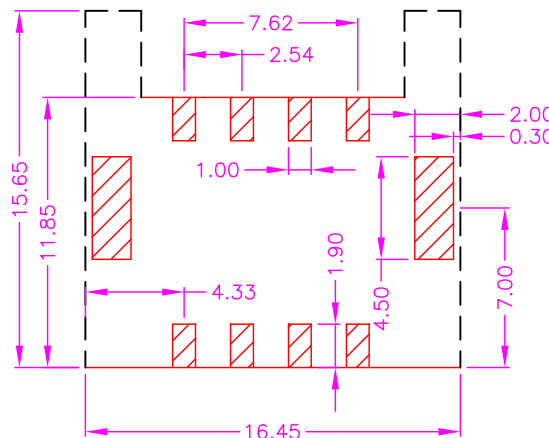
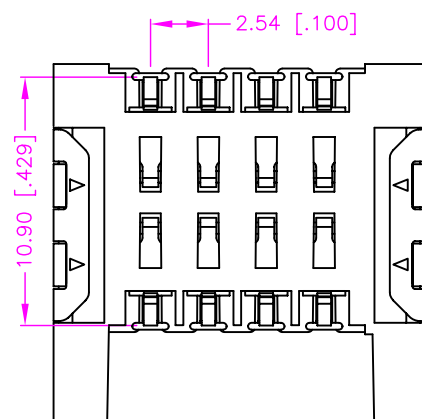
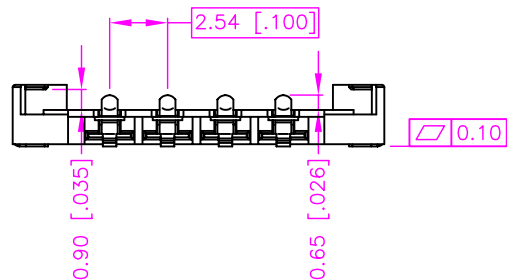
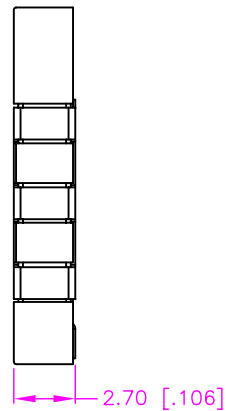
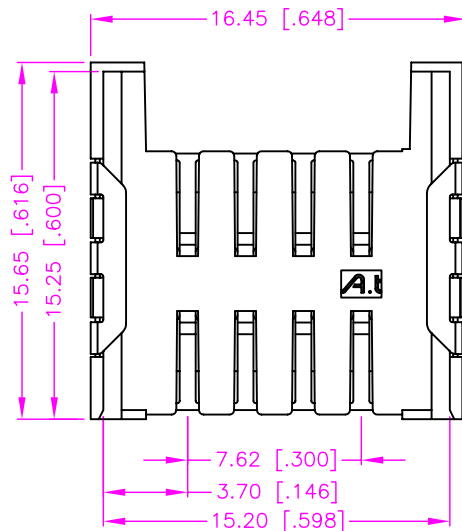
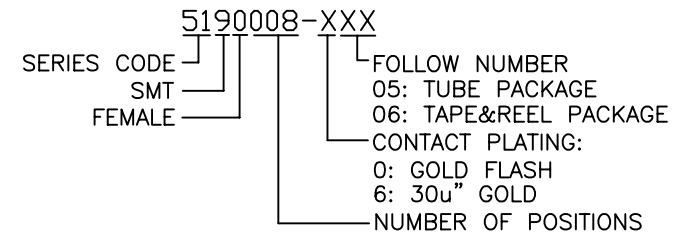
MATERIALS

- HOUSING : HI.-TEMP.PLASTIC(UL 94V-0).BLACK
- TERMINAL : COPPER ALLOY.(t=0.15mm)
GOLD PLATED OVER NICKEL
- FORK : COPPER ALLOY. (t=0.20mm)
TIN PLATED OVER NICKEL

SPECIFICATION

- CURRENT RATING : 1.0 A MAX.
- DIELECTRIC WITHSTANDING VOLTAGE :
500V AC R.M.S. FOR ONE MINUTE.
- INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
- CONTACT RESISTANCE : 30mΩ MAX.
- OPERATING TEMPERATURE : -40°C TO +85°C.

ORDER INFORMATION:



RECOMMEND P.C.B. LAYOUT
TOLERANCE ±0.05
TOP VIEW

TOLERANCE .0=±.38 [.015] .00=±.25 [.010] .000=±. .0000=±. ANG.=±3°		DRAWER <i>Enson</i>		 ASTRON TECHNOLOGY CORP.
UNITS : mm [inch]		CHECK <i>ME</i>		
SCALE NONE		APP'D <i>LJON</i>		NAME
SIZE A4		PRODUCT SPEC. —		SIM CARD 8P 2.54PH
SHEET 1 OF 1		REV. E		DRAW NO. R5190008-X05(06)